## Ordering Information

| $\mathrm{BV}_{\mathrm{DSS}} /$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{BV}_{\mathrm{DGS}}$ |

*Same as SOT-89. Product supplied on 2000 piece carrier tape reels. ${ }^{+}$MIL visual screening available.

## Features

- Low threshold - 1.6 V max.
- High input impedance
- Low input capacitance - 125pF max.
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage
- Complementary N - and P-channel devices


## Applications

- Logic level interfaces - ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches

| Absolute Maximum Ratings |  |
| :--- | ---: |
| Drain-to-Source Voltage | $\mathrm{BV}_{\mathrm{DSS}}$ |
| Drain-to-Gate Voltage | $\mathrm{BV}_{\mathrm{DGS}}$ |
| Gate-to-Source Voltage | $\pm 20 \mathrm{~V}$ |
| Operating and Storage Temperature | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Soldering Temperature* | $300^{\circ} \mathrm{C}$ |

* Distance of 1.6 mm from case for 10 seconds.


## 11/12/01

## Thermal Characteristics

| Package | $\mathrm{I}_{\mathrm{D}}$ (continuous) $^{*}$ | $\mathrm{I}_{\mathrm{D}}$ (pulsed) | Power Dissipation <br> $@ \mathrm{~T}_{\mathrm{A}}=\mathbf{2 5} \mathbf{C}$ | $\theta_{\mathrm{jc}}$ <br> ${ }^{\circ} \mathbf{C} / \mathbf{W}$ | $\theta_{\mathrm{ia}}$ <br> ${ }^{\circ} / \mathbf{W}$ | $\mathrm{I}_{\mathrm{DR}}{ }^{*}$ | $\mathrm{I}_{\mathrm{DRM}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TO-243AA | 0.89 A | 4.5 A | $1.6 \mathrm{~W}^{\dagger}$ | 15 | $78^{\dagger}$ | 0.89 A | 4.5 A |

* $\mathrm{I}_{\mathrm{D}}$ (continuous) is limited by max rated $\mathrm{T}_{\mathrm{j}}$.
$\dagger$ Mounted on FR5 board, $25 \mathrm{~mm} \times 25 \mathrm{~mm} \times 1.57 \mathrm{~mm}$. Significant $P_{D}$ increase possible on ceramic substrate.

Electrical Characteristics (@ $25^{\circ} \mathrm{C}$ unless otherwise specified)

| Symbol | Parameter | Min | Typ | Max | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BV ${ }_{\text {DSS }}$ | Drain-to-Source Breakdown Voltage | 40 |  |  | V | $V_{G S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{GS}(\text { (th) }}$ | Gate Threshold Voltage | 0.6 |  | 1.6 | V | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ |
| $\Delta \mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Change in $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ with Temperature |  | -3.8 | -4.5 | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ |
| $\mathrm{I}_{\text {GSS }}$ | Gate Body Leakage |  |  | 100 | nA | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| $\mathrm{I}_{\text {DSS }}$ | Zero Gate Voltage Drain Current |  |  | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=$ Max Rating |
|  |  |  |  | 1 | mA | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0.8 \text { Max Rating } \\ & \mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C} \end{aligned}$ |
| $\mathrm{I}_{\mathrm{D}(\mathrm{ON})}$ | ON-State Drain Current | 1.0 | 1.7 |  | A | $\mathrm{V}_{\mathrm{GS}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=15 \mathrm{~V}$ |
|  |  | 4.0 | 4.5 |  |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=15 \mathrm{~V}$ |
| $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ | Static Drain-to-Source ON-State Resistance |  | 1.25 | 1.5 | $\Omega$ | $\mathrm{V}_{\mathrm{GS}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=300 \mathrm{~mA}$ |
|  |  |  | 0.8 | 1.0 |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.5 \mathrm{~A}$ |
| $\Delta \mathrm{R}_{\text {DS(ON) }}$ | Change in $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ with Temperature |  |  | 0.75 | \%/ ${ }^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.5 \mathrm{~A}$ |
| $\mathrm{G}_{\text {FS }}$ | Forward Transconductance | 0.5 | 0.7 |  | ठ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2.0 \mathrm{~A}$ |
| $\mathrm{C}_{\text {ISS }}$ | Input Capacitance |  | 70 | 125 | pF | $\begin{aligned} & V_{G S}=0 V, V_{D S}=20 \mathrm{~V} \\ & f=1 \mathrm{MHz} \end{aligned}$ |
| $\mathrm{C}_{\text {OSS }}$ | Common Source Output Capacitance |  | 50 | 70 |  |  |
| $\mathrm{C}_{\mathrm{RSS}}$ | Reverse Transfer Capacitance |  | 20 | 25 |  |  |
| $\mathrm{t}_{\mathrm{d}(\mathrm{ON})}$ | Turn-ON Delay Time |  |  | 10 | ns | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=20 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{D}}=500 \mathrm{~mA}, \\ & \mathrm{R}_{\mathrm{GEN}}=25 \Omega \end{aligned}$ |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time |  |  | 10 |  |  |
| $\mathrm{t}_{\mathrm{d} \text { (OFF) }}$ | Turn-OFF Delay Time |  |  | 25 |  |  |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 13 |  |  |
| $\mathrm{V}_{\text {SD }}$ | Diode Forward Voltage Drop |  | 1.2 | 1.8 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=1.5 \mathrm{~A}$ |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time |  | 300 |  | ns | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=1 \mathrm{~A}$ |

Notes:

1. All D.C. parameters $100 \%$ tested at $25^{\circ} \mathrm{C}$ unless otherwise stated. (Pulse test: $300 \mu \mathrm{~s}$ pulse, $2 \%$ duty cycle.)
2. All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit



## Typical Performance Curves

Output Characteristics


Transconductance vs. Drain Current


Maximum Rated Safe Operating Area


Saturation Characteristics


Power Dissipation vs. Ambient Temperature


Thermal Response Characteristics


## Typical Performance Curves



